

HDAS-16, HDAS-8

12-Bit, 50kHz, Complete Data Acquisition Systems

FEATURES

- Miniature 62-pin cermanic package
- 12-Bit resolution, 50kHz throughput
- Full-scale input range from 50mV to 10V
- Three-state outputs
- 16 S.E. or 8 differential input channels
- · Auto-sequencing channel addressing
- MIL-STD-883 versions
- . No missing codes

GENERAL DESCRIPTION

Using thin and thick-film hybrid technology, DATEL offers complete low-cost data acquisition systems with superior performance and reliability.

The HDAS-8 (with 8 differential input channels) and the HDAS-16 (with 16 single-ended input channels) are complete, highperformance, 12-bit data acquisition systems in 62-pin packages. Each HDAS may be expanded up to 32 singleended or 16 differential channels by adding external multiplexers.

Internal channel address sequencing is automatic after each conversion, or the user may supply external channel addresses.



Internal HDAS circuitry includes:

- Analog input multiplexer (16 S.E. or 8 diff.)
- Resistor-programmable instrumentation amplifier
- Sample-and-hold circuit complete with MOS hold capacitor
- 10 Volt buffered reference
- 12-bit A/D converter with three-state outputs and control logic

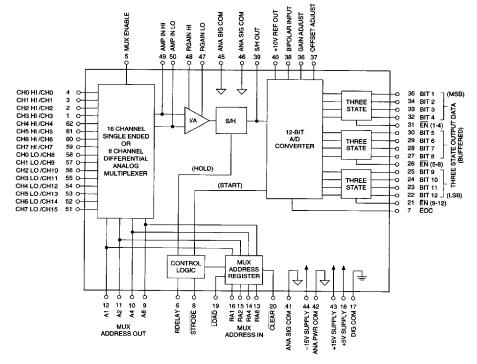


Figure 1. HDAS-16 and HDAS-8 Functional Block Diagram

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Hybrid Data Acquisition Systems



ABSOLUTE MAXIMUM RATINGS

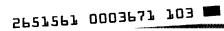
PARAMETERS	MIN.	TYP.	MAX.	UNITS
+15V Supply (pin 43)	-0.5	l –	+18	Volts
-15V Supply (pin 44)	+0.5	· –	-18	Volts
+5V Supply (pin 18)	-0.5	ł <u> </u>	+7	Volts
Analog Inputs ①	-35		+35	Volts
Digital Inputs	-0.5	_	+7	Volts
Thermal Resistances:	- 1		1	1
Junction-Case	<u> </u>	_	15	°C/Watt
Case-Ambient	1 —	_	15	°C/Watt
Junction-Ambient	1 -	=	30	°C/Watt
Lead Temp. (10 seconds)	· -	_	300	°C

FUNCTIONAL SPECIFICATIONS

(The following specifications apply over the operating temperature range and power supply range unless otherwise indicated.)

ANALOG INPUTS	MIN.	TYP.	MAX.	UNITS
Signal Range, Unipolar				
Gain = 1	0	_	+10	Volts
Gain = 200	_	_	+50	m۷
Signal Range, Bipolar	ĺ			
Gain = 1	-10	_	+10	Volts
Gain = 200	-50	_	+50	mV
input Gain Equation ②	(3ain = 1 + (2	0kΩ/RGAIN)
Gain Equation Error	_	_	±0.1	%
instrumentation Amplifier				
Input Impedance	108	1012	_	Ohms
Input Bias Current:				
+25°C	l – .	l – _	±250	pA
-55 to +125°C		Doubles e	very 10°C	
input Offset Current:			1	
+25°C			±1	nA
-55 to +125°C		Doubles e	very 10°C	
Multiplexer				
Channel ON Resistance		_	2	kΩ
Channel OFF Input Leakage	_	±30	_	pА
Channel OFF Output Leakage	l –	±1	_	nA
Channel ON Leakage	l –	±100	<u> </u>	pΑ
input Capacitance		l		
HDAS-16, Channel ON	l –	100	_	pF
HDAS-8, Channel ON	_	50	_	pF
+25°C, Channel OFF	<u> </u>	5	_	pF
Input Offset Voltage				
Gain = 1, +25°C		_	±2	mV
-55 to +125°C (max.)	(±3	Sppm/°CxG	ain) ±20ppm	rc .
Gain = 200, +25°C	_	_	±100	m۷
-55 to +125°C (max.)	(±3	Sppm/°C x G	ain) ±20ppm	/°C
Common Mode Range	±10	_	_	Volts
CMRR, Gain = 1, at 60Hz	70	82	-	dB
Input Voltage Noise, Gain = 1				
(Referred to input)	_	150	200	μVrms
Channel Crosstalk			-80	ď₿
PERFORMANCE				,
Resolution	12	-		Bits
Integral Nonlinearity				
0 to +70°C	-	-	±1	LSB
-55 to +125°C	-	-	±1	LSB
Differential Nonlinearity			ł	
0 to +70°C	-	-	±1	LSB
-55 to +125°C		<u> </u>	±1	LSB
No Missing Codes	Overt	he operating	temperature	range

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PERFORMANCE (cont.)	MIN.	TYP.	MAX.	UNITS
Unipolar Zero Error				
+25°C ③		_	±0.1	%F\$R
55 to +125°C	_	_	±0.3	%FSR
Bipolar Zero Error				
+25°C ③	_	_	±0.1	%FSR
-55 to +125°C	_	-	±0.3	%FSR
Bipolar Offset Error				
+25°C ③	_	_	±0.1	%FSR
-55 to +125°C	_	_	±0.3	%FSR
Gain Error			10.0	70. 011
+25°C ③			±0.2	%
		-	±0.2	%
-55 to +125°C		L=	±0.3	70
DYNAMIC CHARACTERIST	ics		•	
Acquisition Time, Gain = 1		!	İ	
+25°C	_	9	10	μs
-55 to +125°C	_	_	15	μs
Aperture Delay Time	_	_	500	ns
Aperture Uncertainty		l _	1	l ns
S/H Droop Rate	l <u>-</u>	1 _	±1	μV/μs
-	_	-	±0.01	
Feedthrough	_	1 -	±0.01	%
A/D Conversion Time			_	
+25°C	_	6	8	μs
-55 to +125°C	_	-	10	μs
Throughput Rate				
+25°C	50	66	_	kHz
-55 to +125°C	33	-	_	kHz
DIGITAL INPUTS				
Logic Levels				
(Pins 8, 13–16, 19–21, 26, 31)		1		
Logic 1	+2.0	l	+5.5	Volts
Logic 0	0	_	+0.8	Volts
(Pin 5)	"	i	10.0	10,10
Logic 1	+4.0		+5.5	Volts
-	0	_	+0.8	Volts
Logic 0	,	_	+0.0	VOILS
Logic Loading			1	
(Pins 5, 8, 13–16, 19–21,				İ
26, 31)			مد ا	
Logic 1	_	-	±10	μA
Logic 0	_	-	±10	μА
Multiplexer Address Set-up Time	20		-	ns
ENABLE to Data Valid Delay	-	20	30	ns
STROBE @	40			ns
OUTPUTS				
Logic Levels (Output Data)				<u> </u>
Logic 1	+2.4	l _	l _	Volts
Logic 1 (pin 7)	+2.5	_	_	Volts
Logic (pin 7)			+0.4	Volts
•	-	1 -	70.4	VOII.5
(Pins 9, 10, 11, and 12)	.05			Volts
Logic 1	+2.5	-	_	
Logic 0	_	-	+0.4	Volts
Logic Loading				_
Logic 1	-	-	-400	μA
Logic 0	-	-	+4	mA
Internal Reference:	1			
	+9.99	+10.00	+10.01	Volts
Voltage, +25°C				
Voltage, +25°C Drift	_	_	±20	ppm/°C
	_	_	±20 1	ppm/°C mA



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FUNCTIONAL SPECIFICATIONS (Continued)

POWER REQUIREMENTS	MIN.	TYP.	MAX.	UNITS
Power Supply Ranges				
+15V Supply	+14.5	+15.0	+15.5	Volts
-15V Supply	-14.5	-15.0	-15.5	Volts
+5V Suppy	+4.75	+5.0	+5.25	Volts
Power Supply Currents				
+15V Supply	_	_	+33	mA
-15V Supply	_	_	-30	mA
+5V Suppy	_		+15	mA
Power Dissipation	-	_	1.25	Watts
PHYSICAL/ENVIRONMENT	AL			
Operating Temp. Range, Case				
MC Models	0	_	+70	°C
MM/883 Models	-55		+125	•℃
Storage Temperature Range	-65	_	+150	°C
Weight		1.4 ounces	(39.7 grams)	
Package Type	ŀ	62-ріп сеі	manic DIP	

Footnotes:

- Analog inputs will withstand ±35V with power on. If the power is off, the maximum safe input (no damage) is ±20V.
- ② The gain equation error is guaranteed before external trimming and applies at gains less than 50. This error increases at gains over 50.
- Adiustable to zero.

TECHNICAL NOTES

- Input channels are protected to 20 Volts beyond the power supplies. All digital output pins have one second shortcircuit protection.
- To retain high system throughput rates while digitizing low-level signals, apply external high-gain amplifiers for each channel. DATEL's AM-551 is suggested for such amplifier-per-channel applications.
- The HDAS devices have self-starting circuits for freerunning sequential operation. If, however, in a power-up condition the supply voltage slew rate is less than 3V per microsecond, the free running state might not be initialized. Apply a negative pulse to the STROBE, to eliminate this condition.
- For unipolar operation, connect BIPOLAR INPUT (pin 38) to S/H OUT (pin 39). For bipolar operation, connect BIPOLAR INPUT (pin 38) to +10V REFERENCE OUT (pin 40).
- RDELAY may be a standard value 5% carbon composition or film-type resistor.
- RGAIN must be very accurate with low temperature coefficients. If necessary, fabricate the gain resistor from a precision metal-film type in series with a low value trim resistor or potentiometer. The total resistor temperature coefficient must be no greater than ±10ppm/°C.
- 7. ANALOG SIGNAL COMMON, POWER COMMON and DIGITAL COMMON are connected internally. For optimal performance, tie all ground pins (17, 41, 42, 45, 46) directly to a large analog ground plane beneath the package.
- 8. For HDAS-16, tie pin 50 to a "signal source common" if possible. Otherwise tie pin 50 to pin 41 (ANA SIG COM).

INPUT/OUTPUT CONNECTIONS

	INPUT/OUTPUT CONNECTI	ONS
PIN NO.	HDAS-16	HDAS-8
1	CH3 IN	CH3 HIGH IN
2	CH2 IN	CH2 HIGH IN
3	CH1 IN	CH1 HIGH IN
4	CH0 IN	CH0 HIGH IN
5	MUX ENABLE	*
6	RDELAY	*
7	EOC	*
8	STROBE	*
9	A8 MULTIPLEXER	*
10	A4 ADDRESS	*
11	A2 OUT	
12	A1	
13 14	RAS MULTIPLEXER	
15	RA4 ADDRESS RA2 IN	
	RA2 IN	1 :
16 17	DIGITAL COMMON	
18		
19	+5V SUPPLY LOAD	
20	CLEAR	.
21	ENABLE (Bits 9–12)	
22	BIT 12 (LSB)	
23	BIT 11	
24	BIT 10	*
25	BIT 9	*
26	ENABLE (Bits 5-8)	*
27	BIT 8	*
28	BIT 7	*
29	BIT 6	*
30	BIT 5	*
31	ENABLE (Bits 1-4)	*
32	BIT 4	*
33	BIT 3	*
34	BIT 2	*
35	BIT 1 (MSB)	*
36	GAIN ADJUST	*
37	OFFSET ADJUST	*
38	BIPOLAR INPUT	*
39	SAMPLE/HOLD OUT	*
40	+10V REFERENCE OUT	*
41	ANALOG SIGNAL COMMON	*
42	ANALOG POWER COMMON	*
43	+15V SUPPLY	
44	-15V SUPPLY	*
45	ANALOG SIGNAL COMMON	*
46	ANALOG SIGNAL COMMON	*
47	RGAIN LOW	*
48	RGAIN HIGH	*
49	AMP. IN HIGH ①	
50	AMP. IN LOW ①	*
51	CH15 IN	CH7 LOW IN
52	CH14 IN	CH6 LOW IN
53	CH13 IN	CH5 LOW IN
54	CH12 IN	CH4 LOW IN
55 56	CH11 IN	CH3 LOW IN
	CH10 IN	CH2 LOW IN
57 58	CH9 IN CH8 IN	CH1 LOW IN
58 59	CH8 IN CH7 IN	CH0 LOW IN
60	CH/ IN	CH7 HIGH IN
61	CH5 IN	CH6 HIGH IN CH5 HIGH IN
62	CH4 IN	CH4 HIGH IN
		JI TINGH IN

- * Same as HDAS-16
- ① Caution: Pins 49 and 50 do not have overvoltage protection; therefore, protected multiplexers, such as DATEL's MX-1606 and MX-808 are recommended. See the General Operation description.

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Hybrid Data Acquisition Systems

Table 1. Description of Pin Functions

FUNCTION	LOGIC STATE	DESCRIPTION	
DIGITAL INPUTS			
STROBE	1 to 0	Initiates acquisition and conversion of analog signal	
LOAD	0	Random address mode initiated on falling edge of STROBE	
	1	Sequential address mode	
CLEAR	0	Allows next STROBE pulse to reset MULTIPLEXER ADDRESS to CHO overriding LOAD COMMAND	
MUX ENABLE	0	Disables internal multiplexer Enables internal multiplexer	
MUX ADDRESS IN		Selects channel for random address mode 8, 4, 2, 1 natural binary coding	
DIGITAL OUTPUTS			
EOC (STATUS)	0	Conversion complete	
	1	Conversion in process	
ENABLE (1-4)	0	Enables three-state outputs bits 1-4	
	1	Disables three-state outputs bits 1-4	
ENABLE (5-8)	0	Enables three-state outputs bits 5-8	
	1	Disables three-state outputs bits 5-8	
ENABLE (9-12)	0	Enables three-state outputs bits 9-12	
	1	Disables three-state outputs bits 9-12	
MUX ADDRESS OUT		Output of multiplexer address register 8, 4, 2, 1 natural binary coding	
ANALOG INPUTS		DESCRIPTION	
CHANNEL INPUTS		Limit voltage to ±20V beyond power supplies	
BIPOLAR INPUT		For unipolar operation, connect to pin 39 (S/H OUT). For bipolar operation, connect to in 40 (+10V OUT)	
AMP. IN LOW AMP. IN HIGH		These pins are direct inputs to the instrumentation amplifier for external channel expansion beyond 16SE or 8D channels.	
ANALOG OUTPUTS	·		
S/H OUT		Sample/hold output	
+10V REFERENCE C	UT	Buffered +10V reference output	
ADJUSTMENT PINS			
ANALOG SIGNAL CO	MMON	Low level analog signal return	
GAIN ADJUSTMENT		External gain adjustment. See calibration instructions.	
OFFSET ADJUSTME	NT	External offset adjustment. See calibration instructions.	
RGAIN		Optional gain selection point. Factory adjusted for G = 1 when left open.	
RDELAY		Optional acquisition time adjustment when connected to +5V. Factory adjusted for 9µs. Must be connected to +5V either directly or through a resistor.	

Table 2. Calibration Table

UNIPOLAR RANGE	ADJUST	INPUT VOLTAGE
0 to +5V	ZERO GAIN	+0.6mV +4.9982V
0 to +10V	ZERO GAIN	+1.2mV +9.9963V
BIPOLAR RANGE		
±2.5V	OFFSET GAIN	-2.4994V +2.4982V
±5V	OFFSET GAIN	-4.9988V +4.9963V
±10V	OFFSET GAIN	-9.9976V +9.9927V

CALIBRATION PROCEDURES

- 1. Offset and gain adjustments are made by connecting two 20k trim potentiometers as shown in Figure 2.
- 2. Connect a precision voltage source to pin 4 (CH0 IN). If the HDAS-8 is used, connect pin 58 (CH0 LOW IN) to analog ground. Ground pin 20 (CLEAR) and momentarily short pin 8 (STROBE). Trigger the A/D by connecting pin 7 (EOC) to pin 8 (STROBE). Select proper value for RGAIN and RDELAY by referring to Table 3.
- 3. Adjust the precision voltage source to the value shown in Table 2 for the unipolar zero adjustment (ZERO + 1/2LSB) or the bipolar offset adjustment (-FS + 1/2LSB). Adjust the offset trim potentiometer so that the output code flickers equally between 0000 0000 0000 and 0000 0000 0001.
- 4. Change the output of the precision voltage source to the value shown in Table 2 for the unipolar or bipolar gain adjustment (+FS - 1 1/2LSB). Adjust the gain trim potentiometer so that the output flickers equally between 1111 1111 1110 and 1111 1111 1111.

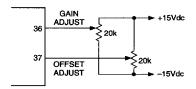


Figure 2. External Adjustment

GENERAL OPERATION

The HDAS devices accept either 16 single-ended or 8 differential input signals. For single-ended circuits, the AMP IN LOW (pin 50) input to the instrumentation amplifier must terminate at ANALOG SIGNAL COMMON (pin 41). For differential circuits, both the HIGH and LOW signal inputs must terminate externally for each channel. Tie unused channels to the ANALOG SIGNAL COMMON (pin 41). To obtain additional channels, connect external multiplexers to the AMP IN HIGH (pin 49) and AMP IN LOW (pin 50). Using this scheme, the HDAS-16 can provide 32 single-ended expansion channels while the HDAS-8 can provide up to 16 differential expansion channels. DATEL's MX Series multiplexers are recommended.

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The acquisition time is the amount of time the multiplexer, instrumentation amplifier, and sample/hold require to settle within a specified range of accuracy after STROBE (pin 8) goes low. The acquisition time period can be observed by measuring how long EOC is low after the falling edge of STROBE (see Figure 4). For higher gains, increase the acquisition time. Do this by connecting a resistor from RDELAY (pin 6) to +5V (pin 18). An external resistor, RGAIN, can be added to increase the gain value. The gain is equal to 1 without an RGAIN resistor. Table 3 refers to the appropriate RDELAY and RGAIN resistors required for various gains.

The HDAS devices enter the hold mode and are ready for conversion as soon as the one-shot (controlling acquisition time) times out. An internal clock is gated ON, and a start-convert pulse is sent to the 12-bit A/D converter, driving the EOC output high.

The HDAS devices can be configured for either bipolar or unipolar operation (see Table 2). The conversion is complete within a maximum of 10 microseconds. The EOC now returns low, the data is valid and sent to the three-state output buffers. The sample/hold amplifier is now ready to acquire new data. The next falling edge of the STROBE pulse repeats the process for the next conversion.

MULTIPLEXER ADDRESSING

The HDAS devices can be configured in either random or sequential addressing modes. Refer to Table 5 and the subsequent descriptions. The number of channels sequentially addressed can be truncated using the MUX ADDRESS OUT (pins 9, 10, 11 and 12) and appropriate decoding circuitry for the highest channel desired. The decoding circuit can drive the CLEAR (pin 20) function low to reset the addressing to channel 0.

Table 3. Input Range Parameters (Typical)

INPUT RANGE ① ②	GAIN	RGAIN (Ω)	RDELAY (Ω) ③	THROUGHPUT @	SYSTEM ACCURACY (% OF FSR)
±10V	1	OPEN	0 (SHORT)	66.6kHz	±0.009
±5V	2	20.0k	0 (SHORT)	66.6kHz	±0.009
±2.5V	4	6.667k	0 (SHORT)	66.6kHz	±0.009
±1V	10	2.222k	0 (SHORT)	66.6kHz	±0.009
±200mV	50	408.2	7k	40.0kHz	±0.010
±100mV	100	202.0	21k ′	25.6kHz	±0.011
±50mV	200	100.5	51k	14.5kHz	±0.016

Notes

RGAIN (
$$\Omega$$
) = $\frac{20,000}{(GAIN - 1)}$

RDELAY (Ω) = [Total Acquisition Delay (μ s) x 1000] - 9000

- ① The analog input range to the A/D converter is 0 to +10V for unipolar signals and ±10V for bipolar signals.
- Full scale can be accommodated for analog signal ranges of ±50mV to ±10V.
- Tor gains between 1 and 10, RDELAY (pin 6) must be shorted to +5V (pin 18).
- Throughput period equals acquisition and settling delay, plus A/D conversion period (10 microseconds maximum).

Table 4. Output Coding

UNIPOLAR			STRA	IGHT B	INARY
INPUT	0 to +10V	0 to +5V	MSB		LSB
+FS - 1LSB	+9.9976	+4.9988	1111	1111	1111
+1/2FS	+5.0000	+2.5000	1000	0000	0000
+1LSB	+0.0024	+0.0012	0000	0000	0001
ZERO	0.0000	0.0000	0000	0000	0000

BIPOLAR			OFFS	SET BIN	ARY*
INPUT	±10V	±5V	MSB		LSB
+FS - 1LSB	+9.9951	+4.9976	1111	1111	1111
+1/2FS	+5.0000	+2.5000	1100	0000	0000
+1LSB	+0.0049	+0.0024	1000	0000	0001
ZERO	0.0000	0.0000	1000	0000	0000
-FS + 1LSB	-9.9951	-4.9976	0000	0000	0001
-FS	-10.000	-5.0000	0000	0000	0000

^{*} For 2's complement coding, add an inverter to the MSB line.

Table 5. Mux Channel Addressing

		PIN				
		MUX A	DRESS	3] 💆	
5	13	14	15	16	8₹	
MUX ENABLE	RA8	RA4	RA2	RA1	CHANNEL	
0	X	Х	Х	Х	NONE	
1	0	0	0	0	0	
1	0	0	0	1	1	
1	0	0	1	0	2	
1	0	0	1	-1	3	HDAS-8
1	0	1	0	0	4	(3-BIT ADDRESS)
1	0	1	0	1	5	AUUNESSI
1	0	1	1	0	6	
1	0	1	1	1	7	
1	1	0	0	0	8	
1	1	0	0	1	9	
1	1	0	1	0	10	HDAS-16
1	1	0	1	1	11	(4-BIT
1	1	1	0	0	12	ADDRESS)
1	1	1 1	0	1	13	_
1	1	1	1	0	14	ĺ
1	1	1	1	1	15	
				•		

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RANDOM ADDRESSING

Set pin 19 (LOAD) to logic 0. The next falling edge of STROBE will load the MUX CHANNEL ADDRESS present on pin 13 to pin 16. Digital address inputs must be stable 20ns before and after falling edge of the STROBE pulse.

FREE RUNNING SEQUENTIAL ADDRESSING

Set pin 19 (LOAD) and pin 20 (CLEAR) to logic 1 or leave open. Connect pin 7 (EOC) to pin 8 (STROBE). The falling edge of EOC will increment channel address. This means that when the EOC is low, the digital output data is valid for the previous channel (CHn – 1) rather than the channel indicated on MUX ADDRESS OUTPUT. The HDAS will continually scan all channels.

Example:

CH4 has been addressed and a conversion takes place. The EOC goes low. That channel's (CH4's) data becomes valid, but MUX ADDRESS OUTPUT is now CH5.

TRIGGERED SEQUENTIAL ADDRESSING

Set pin 19 (LOAD) and pin 20 (CLEAR) to logic 1 or leave open. Apply a falling edge trigger pulse to pin 8 (STROBE). This negative transition causes the contents of the address counter to be incremented by one, followed by an A/D conversion in 9 microseconds.

INPUT VOLTAGE PROTECTION

As shown in Figure 3, the multiplexer has reversed biased diodes which protect the input channels from being damaged by overvoltage signals. The HDAS input channels are protected up to 20V beyond the supplies and can be increased by adding series resistors (Ri) to each channel. The input resistor must limit the current flowing through the protection diodes to 10mA.

The value of Ri for a specific voltage protection range (Vp) can be calculated by the following formula:

NOTE: Increased input series resistance will increase multiplexer settling time significantly.

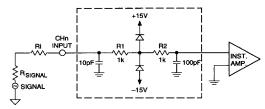
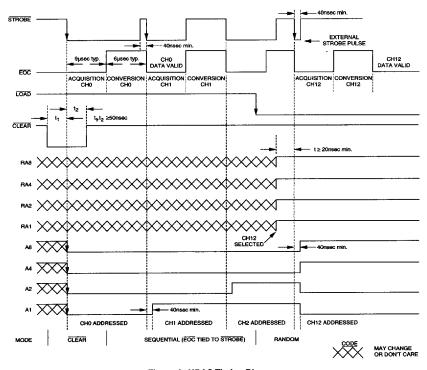
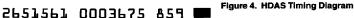


Figure 3. Multiplexer Equivalent Circuit

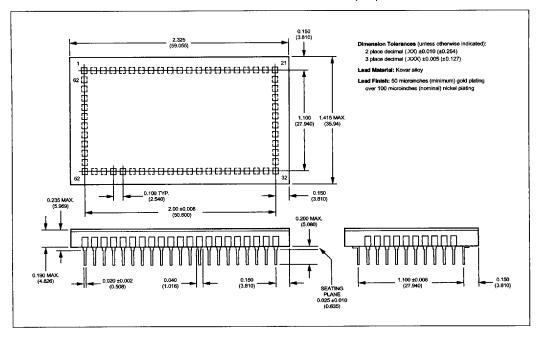




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MECHANICAL DIMENSIONS INCHES (mm)



ORDERING INFORMATION

MODEL NO.	OPERATING TEMP. RANGE
HDAS-16MC	0 to +70°C
HDAS-16MM	-55 to +125°C
HDAS-16/883	-55 to +125°C
HDAS-8MC	0 to +70°C
HDAS-8MM	-55 to +125°C
HDAS-8/883	-55 to +125°C
	board mounting can be ordered through AMP Inc., Component Lead Spring Socket), 62 required.
Contact DATEL. Inc	. for MIL-STD-883 product specifications.
Contact DATEL, Inc	. for wite-5 ru-665 product specifications.